

CALL FOR ABSTRACTS:

Abstract Submission Deadline: September 11, 2020



6TH WORLD CONGRESS ON INTEGRATED COMPUTATIONAL MATERIALS ENGINEERING (ICME 2021)

APRIL 18–22, 2021 | Hyatt Regency Lake Tahoe
Lake Tahoe, Nevada, USA | www.tms.org/ICME2021

ICME 2021 convenes leading researchers and practitioners to share the latest knowledge and advances in the discipline. This congress is the recognized hub of interaction among software developers and process engineers along the entire production chain, as well as for materials scientists and engineers developing new materials.

SHARE YOUR WORK AND NETWORK WITH COLLEAGUES!

Abstracts are requested on the following technical topics:

- Applications: Advanced Manufacturing – Additive Manufacturing
- Applications: Advanced Manufacturing – Other
- Applications: Materials Design & Alloy Modification
- Artificial Intelligence & Machine Learning
- ICME for Non-Metals, Structural Composites, and Ceramics
- ICME in Education
- ICME-Based Design Tools
- Industrial Integration & Success Stories
- Linkage: Process – Microstructure
- Linkage: Structure – Properties
- Material Databases & Platforms
- Materials Qualification
- Microstructure Evolution and Analysis
- Multi-Scale Modeling
- Uncertainty Quantification, Verification & Validation

This congress is
sponsored by

TMS

Materials Processing
& Manufacturing
Division (MPMD) and the
Integrated Computational
Materials Engineering
(ICME) Committee

Learn details and
submit and abstract at
www.tms.org/ICME2021